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Vishay Siliconix

Automotive N-Channel 30 V (D-S) 175 °C MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	30				
$R_{DS(on)}(\Omega)$ at $V_{GS} = 10 \text{ V}$	0.0038				
$R_{DS(on)}(\Omega)$ at $V_{GS} = 4.5 \text{ V}$	0.0050				
I _D (A)	32				
Configuration	Single				
Package	SO-8				

FEATURES

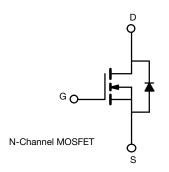
- TrenchFET® power MOSFET
- AEC-Q101 qualified
- 100 % R_q and UIS tested
- Material categorization: for definitions of compliance please see www.vishav.com/doc?99912





ROHS COMPLIANT HALOGEN FREE





ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)					
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		V _{DS}	30	V	
Gate-Source Voltage		V _{GS}	V _{GS} ± 20		
Continuous Drain Current	T _C = 25 °C ^a	- I _D	32		
	T _C = 125 °C		18		
Continuous Source Current (Diode Conduction)		Is	6.4	А	
Pulsed Drain Current b		I _{DM}	100		
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	60		
Single Pulse Avalanche Energy	L=0.11III	E _{AS}	180	mJ	
Maximum Power Dissipation ^b	T _C = 25 °C	- P _D	7.1	W	
	T _C = 125 °C		2.3	VV	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55 to +175	°C	

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	LIMIT	UNIT	
Junction-to-Ambient Po	CB Mount c	R _{thJA}	80	°C/W	
Junction-to-Foot (Drain)		R _{thJF}	21]	

Notes

- a. Package limited
- b. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- c. When mounted on 1" square PCB (FR4 material).

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Static Drain-Source Breakdown Voltage Gate-Source Threshold Voltage Gate-Source Leakage	V _{DS} V _{GS(th)} I _{GSS}	V _{DS} =	= 0 V, I _D = 250 μA : V _{GS} , I _D = 250 μA 0 V, V _{GS} = ± 20 V	30 1.5	-			
Gate-Source Threshold Voltage Gate-Source Leakage	V _{GS(th)}	V _{DS} =	· V _{GS} , I _D = 250 μA		-			
Gate-Source Leakage	I _{GSS}	V _{DS} =		1.5		-	V	
0			0.7.7.		2.0	2.5		
	Inss	$V_{GS} = 0 \text{ V}$	0 v, v _{GS} = ± 20 v	-	-	± 100	nA	
	Inss	40	V _{DS} = 30 V	=	-	1		
Zero Gate Voltage Drain Current	DOO	V _{GS} = 0 V	V _{DS} = 30 V, T _J = 125 °C	-	-	50	μA	
		V _{GS} = 0 V	V _{DS} = 30 V, T _J = 175 °C	-	-	250		
On-State Drain Current a	I _{D(on)}	V _{GS} = 10 V	$V_{DS} \ge 5 \text{ V}$	20	-	-	Α	
		V _{GS} = 10 V	I _D = 14 A	-	0.0031	0.0038	Ω	
	R _{DS(on)}	V _{GS} = 10 V	I _D = 14 A, T _J = 125 °C	-	-	0.0060		
Drain-Source On-State Resistance a		V _{GS} = 10 V	I _D = 14 A, T _J = 175 °C	-	-	0.0070		
		V _{GS} = 4.5 V	I _D = 10 A	-	0.0040	0.0050		
Forward Transconductance b	9 _{fs}	V _{DS} = 15 V, I _D = 14 A		-	107	-	S	
Dynamic ^b								
Input Capacitance	C _{iss}		V _{DS} = 15 V, f = 1 MHz	-	4313	5400	pF	
Output Capacitance	C _{oss}	$V_{GS} = 0 V$		-	868	1090		
Reverse Transfer Capacitance	C _{rss}			-	305	390		
Total Gate Charge c	Qg			-	72	110		
Gate-Source Charge ^c	Q _{gs}	$V_{GS} = 10 \text{ V}$ $V_{DS} = 15 \text{ V}, I_D = 20 \text{ A}$		-	14	-	nC	
Gate-Drain Charge ^c	Q _{gd}			-	8	-		
Gate Resistance	R _g	f = 1 MHz		0.9	1.8	4.9	Ω	
Turn-On Delay Time ^c	t _{d(on)}			-	16	24		
Rise Time ^c	t _r	V_{DD} = 15 V, R_L = 1.5 Ω $I_D \cong$ 10 A, V_{GEN} = 10 V, R_g = 1 Ω		-	10	15	ns	
Turn-Off Delay Time ^c	t _{d(off)}			-	57	86		
Fall Time ^c	t _f			-	8	12		
Source-Drain Diode Ratings and Characte	eristics ^b							
Pulsed Current ^a	I _{SM}			-	-	100	Α	
Forward Voltage	V _{SD}	I _F =	10 A, V _{GS} = 0 V	-	0.75	1.2	V	

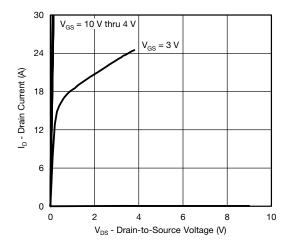
Notes

- a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

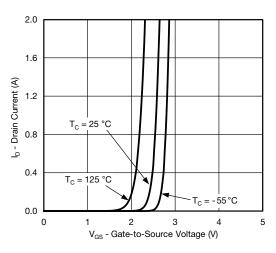
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



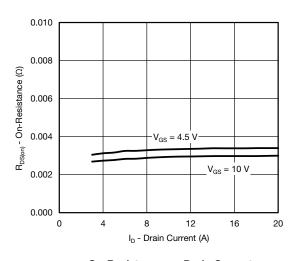
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



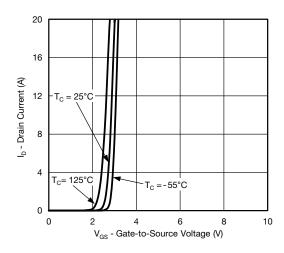
Output Characteristics



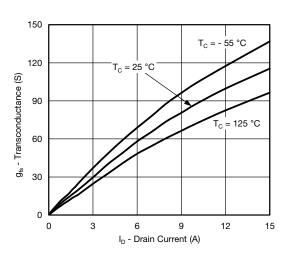
Transfer Characteristics



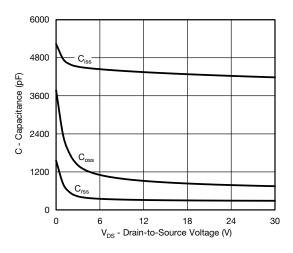
On-Resistance vs. Drain Current



Transfer Characteristics



Transconductance

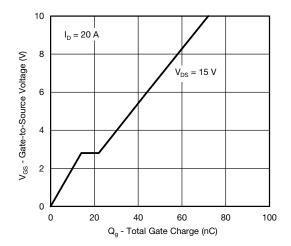


Capacitance

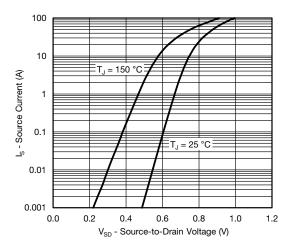
For technical questions, contact: automostechsur



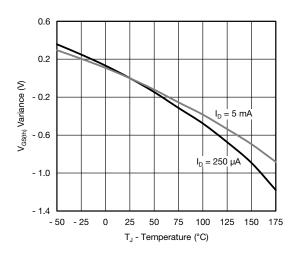
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



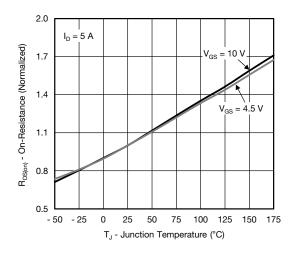
Gate Charge



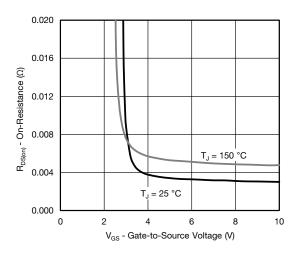
Source Drain Diode Forward Voltage



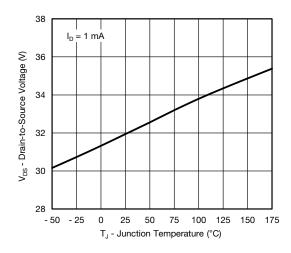
Threshold Voltage



On-Resistance vs. Junction Temperature



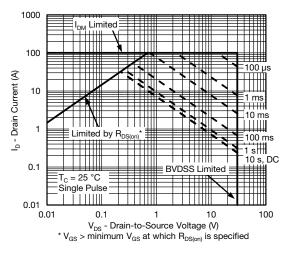
On-Resistance vs. Gate-to-Source Voltage



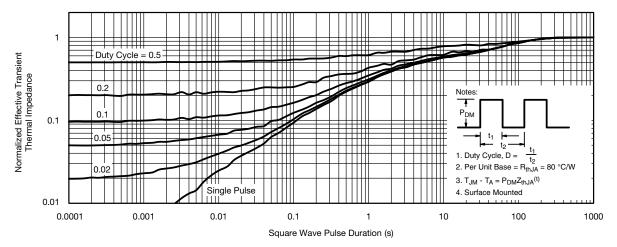
Drain Source Breakdown vs. Junction Temperature



THERMAL RATINGS ($T_A = 25$ °C, unless otherwise noted)



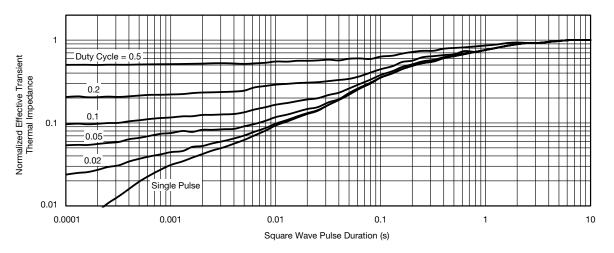
Safe Operating Area



Normalized Thermal Transient Impedance, Junction-to-Ambient

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THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Foot

Note

- The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)

can widely vary depending on actual application parameters and operating conditions.

- Normalized Transient Thermal Impedance Junction-to-Foot (25 °C) are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg267917.





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REVISION HISTORY a						
REVISION	DATE	DESCRIPTION OF CHANGE				
С	21-Sep-15	R _g changed				

Note

a. As of April 2014



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